

Applications

SMPS

AC-DC

DC-DC Converter

Freewheeling Diodes



SBR3A40SA

3.0A SBR SUPER BARRIER RECTIFIER SMA

Product Summary (@ T_A = +25°C)

V _{RRM} (V)	I _O (A)	V _{F(MAX)} (mV)	Ι _{R(MAX)} (μΑ)
40	3	500	400

Features and Benefits

- Low Leakage Current
- Patented Super Barrier Rectifier Technology
- Soft, Fast Switching Capability
- +150°C Operating Junction Temperature
- Lead-Free Finish; RoHS Compliant (Notes 1 & 2)
- Halogen and Antimony Free. "Green" Device (Note 3)
- Qualified to AEC-Q101 Standards for High Reliability
- PPAP Capable (Note 4)

Mechanical Data

- Case: SMA
- Case Material: Molded Plastic, "Green" Molding Compound. UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 1 per J-STD-020
- Terminals: Lead Free Plating (Matte Tin Finish.) Solderable per MIL-STD-202, Method 208 (3)
- Polarity Indicator: Cathode Band
- Weight: 0.064 grams (Approximate)



Top View

Bottom View

Ordering Information (Note 5)

Part Number	Compliance	Case	Packaging
SBR3A40SA-13	Commercial	SMA	5,000/Tape & Reel
SBR3A40SAQ-13	Automotive	SMA	5,000/Tape & Reel

1. EU Directive 2002/95/EC (RoHS) & 2011/65/EU (RoHS 2) compliant. All applicable RoHS exemptions applied.

2. See http://www.diodes.com/quality/lead_free.html for more information about Diodes Incorporated's definitions of Halogen- and Antimony-free, "Green" and Lead-free.

3. Halogen- and Antimony-free "Green" products are defined as those which contain <900ppm bromine, <900ppm chlorine (<1500ppm total Br + Cl) and <1000ppm antimony compounds.

4. Automotive products are AEC-Q101 qualified and are PPAP capable. Automotive, AEC-Q101 and standard products are electrically and thermally the same, except where specified. For more information, please refer to http://www.diodes.com/quality/product_compliance_definitions/.

5. For packaging details, go to our website at http://www.diodes.com/products/packages.html.

Marking Information

Notes:



SV = 4 = Product Type Marking Code YW = Date Code Marking YWW = Date Code Marking Y = Last Digit of Year (ex: 7 for 2007) WW = Week Code 01 to 52XX = Foundry and Assembly Site

Note: 6. Device has a cathode band (as shown above) and may also have a cathode notch.



Maximum Ratings (@T_A = +25°C, unless otherwise specified.)

Single phase, half wave, 60Hz, resistive or inductive load

Characteristic	Symbol	Value	Unit
Peak Repetitive Reverse Voltage Working Peak Reverse Voltage DC Blocking Voltage	V _{RRM} V _{RWM} V _{RM}	40	V
Maximum Voltage Rate of Change (Rated V _R)	dv/dt	10,000	V/µs
RMS Reverse Voltage	V _{R(RMS)}	28	V
Average Rectified Output Current	lo	3	А
Non-Repetitive Peak Forward Surge Current 8.3ms Single Half Sine-Wave Superimposed on Rated Load	I _{FSM}	45	A

Thermal Characteristics

Characteristic	Symbol	Value	Unit
Maximum Thermal Resistance Thermal Resistance Junction to Soldering (Note 7) Thermal Resistance Junction to Ambient (Note 8) Thermal Resistance Junction to Case (Note 8)	$f R_{ heta JS} \ R_{ heta JA} \ R_{ heta JC}$	5 124 14.3	°C/W
Power Dissipation (Note 8) $@T_A = +25^{\circ}C$	PD	1.2	W
Operating and Storage Temperature Range	T _J , T _{STG}	-65 to +150	°C

Electrical Characteristics (@T_A = +25°C, unless otherwise specified.)

Characteristic	Symbol	Min	Тур	Max	Unit	Test Condition
Reverse Breakdown Voltage (Note 9)	V _{(BR)R}	40	-	-	V	$I_{R} = 0.4 mA$
Forward Voltage Drop	V _F	- - -	0.30 0.33 0.43 -	0.35 0.38 0.50 0.48	V	$ \begin{split} I_F &= 0.5A, \ T_J = +25^\circ C \\ I_F &= 1.0A, \ T_J = +25^\circ C \\ I_F &= 3.0A, \ T_J = +25^\circ C \\ I_F &= 3.0A, \ T_J = +125^\circ C \end{split} $
Leakage Current (Note 9)	I _R	-	45 80 9	250 400 40	μA μA mA	$V_R = 5V$, $T_J = +25^{\circ}C$ $V_R = 40V$, $T_J = +25^{\circ}C$ $V_R = 40V$, $T_J = +125^{\circ}C$

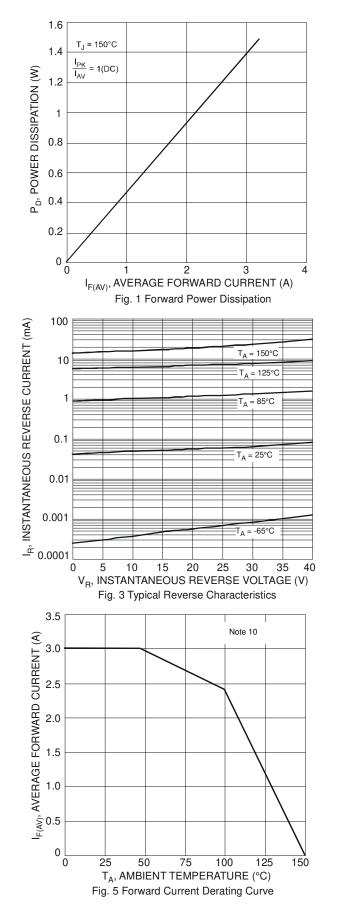
Notes: 7. Theoretical $R_{0,JS}$ calculated from the top center of the die straight down to the PCB cathode tab solder junction.

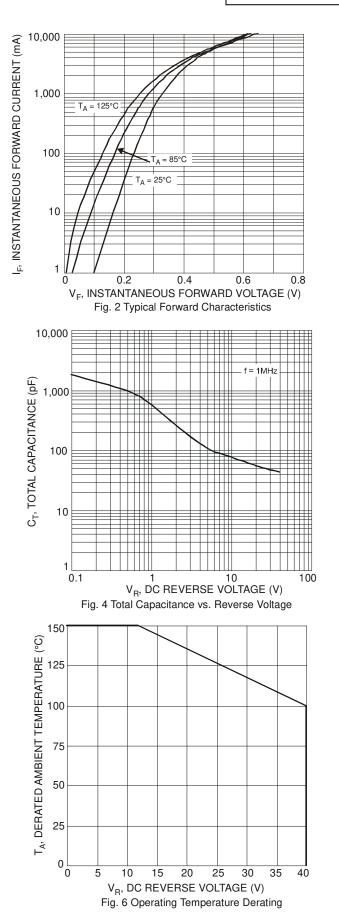
8. FR-4 PCB, 2 oz. Copper, minimum recommended pad layout per http://www.diodes.com/package-outlines.html.

9. Short duration pulse test used to minimize self-heating effect.

10. FR-4 PCB, 2 oz. Copper, single side 16 x MRP, 1" x 1" PC Board.



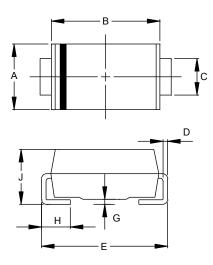






Package Outline Dimensions

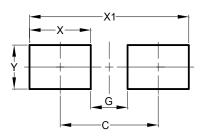
Please see http://www.diodes.com/package-outlines.html for the latest version.



SMA				
Dim	Min	Max		
Α	2.29	2.92		
В	4.00	4.60		
С	1.27	1.63		
D	0.15	0.31		
E	4.80	5.59		
G	0.05	0.20		
Н	0.76	1.52		
J	1.96	2.40		
All Dimensions in mm				

Suggested Pad Layout

Please see http://www.diodes.com/package-outlines.html for the latest version.



Dimensions	Value (in mm)
С	4.00
G	1.50
Х	2.50
X1	6.50
Y	1.70



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